

**VNS3NV04D**

**“OMNIFET II”:  
FULLY AUTOPROTECTED POWER MOSFET**

| TYPE      | R <sub>DS(on)</sub> | I <sub>lim</sub> | V <sub>clamp</sub> |
|-----------|---------------------|------------------|--------------------|
| VNS3NV04D | 120 mΩ (*)          | 3.5 A (*)        | 40 V (*)           |

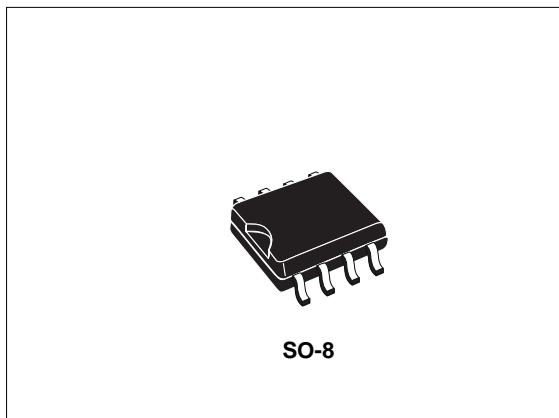
(\*)Per each device

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET

#### DESCRIPTION

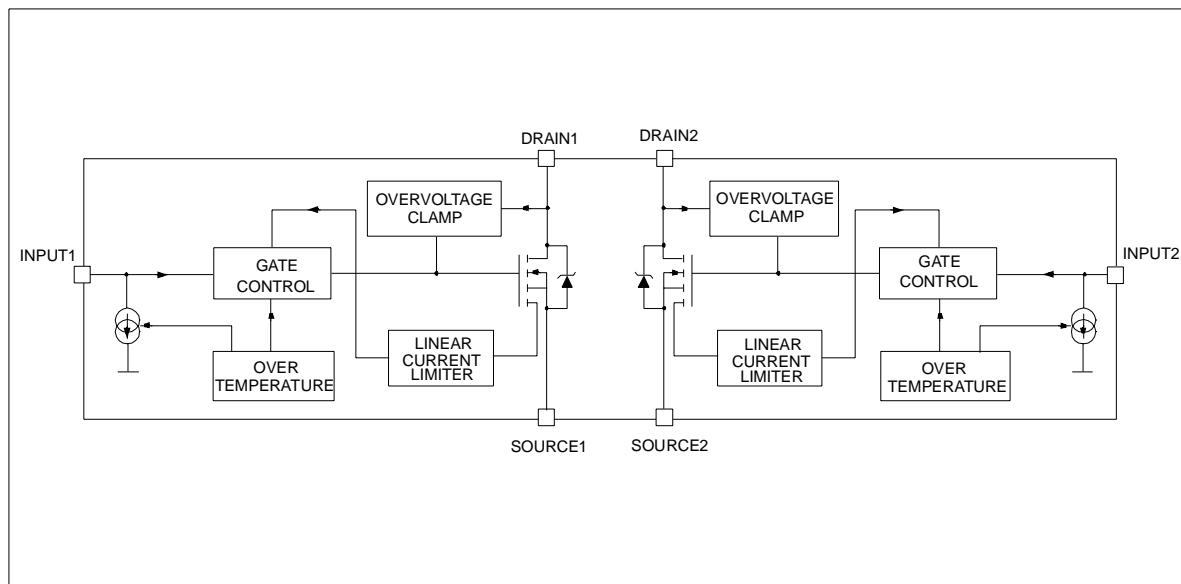
The VNS3NV04D is a device formed by two monolithic OMNIFET II chips housed in a standard SO-8 package. The OMNIFET II are designed in STMicroelectronics VIPower M0-3 Technology: they are intended for replacement of standard Power MOSFETS from DC up to 50KHz

#### BLOCK DIAGRAM



applications. Built in thermal shutdown, linear current limitation and overvoltage clamp protects the chip in harsh environments.

Fault feedback can be detected by monitoring the voltage at the input pin.

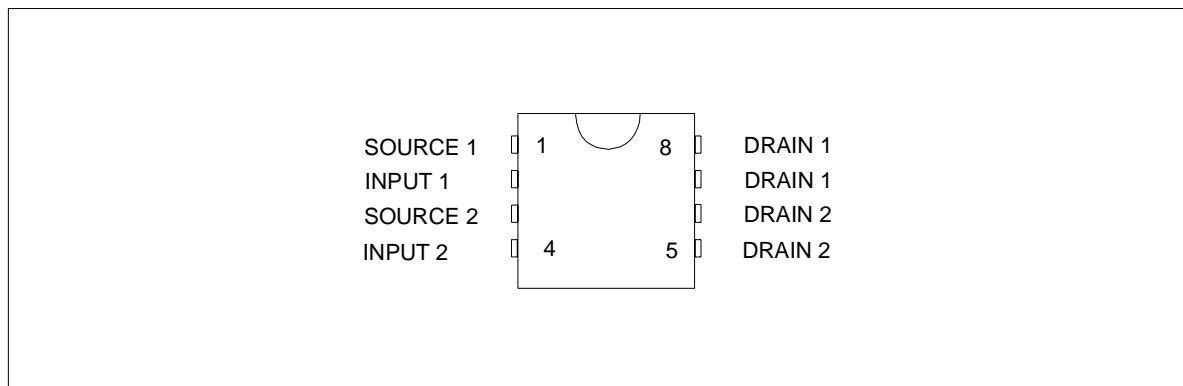


## VNS3NV04D

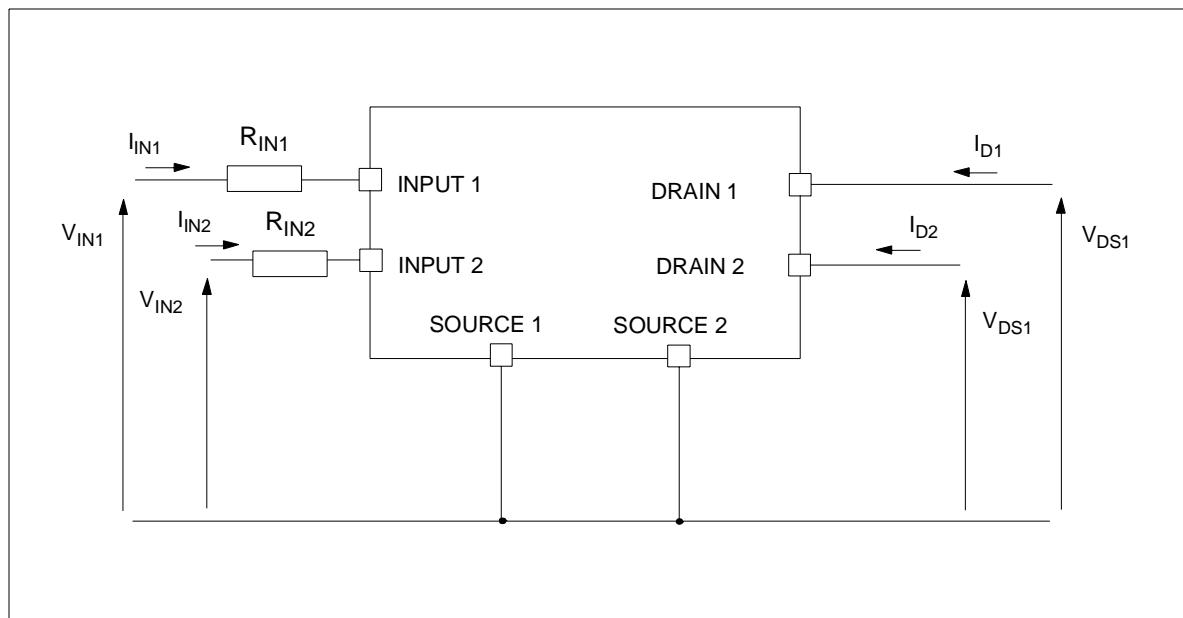
### ABSOLUTE MAXIMUM RATING

| Symbol         | Parameter   | Value              | Unit       |
|----------------|---|--------------------|------------|
| $V_{DSn}$      | Drain-source Voltage ( $V_{INn}=0V$ )                                     | Internally Clamped | V          |
| $V_{INn}$      | Input Voltage   | Internally Clamped | V          |
| $I_{INn}$      | Input Current   | +/-20              | mA         |
| $R_{IN\ MINn}$ | Minimum Input Series Impedance  | 220                | $\Omega$   |
| $I_{Dn}$       | Drain Current   | Internally Limited | A          |
| $I_{Rn}$       | Reverse DC Output Current   | -5.5               | A          |
| $V_{ESD1}$     | Electrostatic Discharge ( $R=1.5K\Omega$ , $C=100pF$ )                    | 4000               | V          |
| $V_{ESD2}$     | Electrostatic Discharge on output pins only ( $R=330\Omega$ , $C=150pF$ ) | 16500              | V          |
| $P_{tot}$      | Total Dissipation at $T_c=25^\circ C$                                     | 4                  | W          |
| $T_j$          | Operating Junction Temperature  | Internally limited | $^\circ C$ |
| $T_c$          | Case Operating Temperature  | Internally limited | $^\circ C$ |
| $T_{stg}$      | Storage Temperature   | -55 to 150         | $^\circ C$ |

### CONNECTION DIAGRAM (TOP VIEW)



### CURRENT AND VOLTAGE CONVENTIONS



**THERMAL DATA**

| Symbol                | Parameter                                      | Value | Unit  |
|-----------------------|--|-------|-------|
| $R_{thj\text{-lead}}$ | Thermal Resistance Junction-lead (per channel) | MAX   | 30    |
| $R_{thj\text{-amb}}$  | Thermal Resistance Junction-ambient            | MAX   | 80(*) |

(\*) When mounted on a standard single-sided FR4 board with 50mm<sup>2</sup> of Cu (at least 35 µm thick) connected to all DRAIN pins of the relative channel.

**ELECTRICAL CHARACTERISTICS** (-40°C < T<sub>j</sub> < 150°C, unless otherwise specified)  
(Per each device)**OFF**

| Symbol      | Parameter  | Test Conditions   | Min       | Typ | Max       | Unit |
|-------------|--|---|-----------|-----|-----------|------|
| $V_{CLAMP}$ | Drain-source Clamp Voltage                       | $V_{IN}=0V$ ; $I_D=1.5A$  | 40        | 45  | 55        | V    |
| $V_{CLTH}$  | Drain-source Clamp Threshold Voltage             | $V_{IN}=0V$ ; $I_D=2mA$   | 36        |     |           | V    |
| $V_{INTH}$  | Input Threshold Voltage                          | $V_{DS}=V_{IN}$ ; $I_D=1mA$   | 0.5       |     | 2.5       | V    |
| $I_{ISS}$   | Supply Current from Input Pin                    | $V_{DS}=0V$ ; $V_{IN}=5V$   |           | 100 | 150       | µA   |
| $V_{INCL}$  | Input-Source Clamp Voltage                       | $I_{IN}=1mA$<br>$I_{IN}=-1mA$   | 6<br>-1.0 | 6.8 | 8<br>-0.3 | V    |
| $I_{DSS}$   | Zero Input Voltage Drain Current ( $V_{IN}=0V$ ) | $V_{DS}=13V$ ; $V_{IN}=0V$ ; $T_j=25^\circ C$<br>$V_{DS}=25V$ ; $V_{IN}=0V$ |           |     | 30<br>75  | µA   |

**ON**

| Symbol       | Parameter                         | Test Conditions   | Min | Typ | Max        | Unit |
|--------------|-----------------------------------|---|-----|-----|------------|------|
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{IN}=5V$ ; $I_D=1.5A$ ; $T_j=25^\circ C$<br>$V_{IN}=5V$ ; $I_D=1.5A$ |     |     | 120<br>240 | mΩ   |

## VNS3NV04D

### ELECTRICAL CHARACTERISTICS (continued) ( $T_j=25^\circ\text{C}$ , unless otherwise specified) DYNAMIC

| Symbol       | Parameter                | Test Conditions  | Min | Typ | Max | Unit        |
|--------------|--------------------------|--|-----|-----|-----|-------------|
| $g_{fs}$ (*) | Forward Transconductance | $V_{DD}=13\text{V}$ ; $I_D=1.5\text{A}$                    |     | 5.0 |     | $\text{s}$  |
| $C_{OSS}$    | Output Capacitance       | $V_{DS}=13\text{V}$ ; $f=1\text{MHz}$ ; $V_{IN}=0\text{V}$ |     | 150 |     | $\text{pF}$ |

### SWITCHING

| Symbol         | Parameter             | Test Conditions   | Min | Typ  | Max  | Unit                   |
|----------------|-----------------------|---|-----|------|------|------------------------|
| $t_{d(on)}$    | Turn-on Delay Time    | $V_{DD}=15\text{V}$ ; $I_D=1.5\text{A}$<br>$V_{gen}=5\text{V}$ ; $R_{gen}=R_{IN\ MINn}=220\Omega$<br>(see figure 1) |     | 90   | 300  | $\text{ns}$            |
| $t_r$          | Rise Time             |   |     | 250  | 750  | $\text{ns}$            |
| $t_{d(off)}$   | Turn-off Delay Time   |   |     | 450  | 1350 | $\text{ns}$            |
| $t_f$          | Fall Time             |   |     | 250  | 750  | $\text{ns}$            |
| $t_{d(on)}$    | Turn-on Delay Time    | $V_{DD}=15\text{V}$ ; $I_D=1.5\text{A}$<br>$V_{gen}=5\text{V}$ ; $R_{gen}=2.2\text{K}\Omega$<br>(see figure 1)      |     | 0.45 | 1.35 | $\mu\text{s}$          |
| $t_r$          | Rise Time             |   |     | 2.5  | 7.5  | $\mu\text{s}$          |
| $t_{d(off)}$   | Turn-off Delay Time   |   |     | 3.3  | 10.0 | $\mu\text{s}$          |
| $t_f$          | Fall Time             |   |     | 2.0  | 6.0  | $\mu\text{s}$          |
| $(dl/dt)_{on}$ | Turn-on Current Slope | $V_{DD}=15\text{V}$ ; $I_D=1.5\text{A}$<br>$V_{gen}=5\text{V}$ ; $R_{gen}=R_{IN\ MINn}=220\Omega$                   |     | 4.7  |      | $\text{A}/\mu\text{s}$ |
| $Q_i$          | Total Input Charge    | $V_{DD}=12\text{V}$ ; $I_D=1.5\text{A}$ ; $V_{IN}=5\text{V}$<br>$I_{gen}=2.13\text{mA}$ (see figure 5)              |     | 8.5  |      | $\text{nC}$            |

### SOURCE DRAIN DIODE

| Symbol       | Parameter                | Test Conditions                                       | Min | Typ | Max | Unit          |
|--------------|--------------------------|---|-----|-----|-----|---------------|
| $V_{SD}$ (*) | Forward On Voltage       | $I_{SD}=1.5\text{A}$ ; $V_{IN}=0\text{V}$             |     | 0.8 |     | $\text{V}$    |
| $t_{rr}$     | Reverse Recovery Time    | $I_{SD}=1.5\text{A}$ ; $dl/dt=12\text{A}/\mu\text{s}$ |     | 107 |     | $\text{ns}$   |
| $Q_{rr}$     | Reverse Recovery Charge  | $V_{DD}=30\text{V}$ ; $L=200\mu\text{H}$              |     | 37  |     | $\mu\text{C}$ |
| $I_{RRM}$    | Reverse Recovery Current | (see test circuit, figure 2)                          |     | 0.7 |     | $\text{A}$    |

### PROTECTIONS (-40°C < $T_j$ < 150°C, unless otherwise specified)

| Symbol     | Parameter                     | Test Conditions  | Min | Typ | Max | Unit             |
|------------|-------------------------------|--|-----|-----|-----|------------------|
| $I_{lim}$  | Drain Current Limit           | $V_{IN}=5\text{V}$ ; $V_{DS}=13\text{V}$   | 3.5 | 5   | 7   | $\text{A}$       |
| $t_{dlim}$ | Step Response Current Limit   | $V_{IN}=5\text{V}$ ; $V_{DS}=13\text{V}$   |     | 10  |     | $\mu\text{s}$    |
| $T_{jsh}$  | Overtemperature Shutdown      |  | 150 | 175 | 200 | $^\circ\text{C}$ |
| $T_{jrs}$  | Overtemperature Reset         |  | 135 |     |     | $^\circ\text{C}$ |
| $I_{gf}$   | Fault Sink Current            | $V_{IN}=5\text{V}$ ; $V_{DS}=13\text{V}$ ; $T_j=T_{jsh}$                                       | 10  | 15  | 20  | $\text{mA}$      |
| $E_{as}$   | Single Pulse Avalanche Energy | $V_{IN}=5\text{V}$ ; $R_{gen}=R_{IN\ MINn}=220\Omega$ ; $L=24\text{mH}$<br>(see figures 3 & 4) | 100 |     |     | $\text{mJ}$      |

(\*) Pulsed: Pulse duration = 300μs, duty cycle 1.5%

## PROTECTION FEATURES

During normal operation, the INPUT pin is electrically connected to the gate of the internal power MOSFET through a low impedance path.

The device then behaves like a standard power MOSFET and can be used as a switch from DC to 50KHz. The only difference from the user's standpoint is that a small DC current  $I_{ISS}$  (typ. 100 $\mu$ A) flows into the INPUT pin in order to supply the internal circuitry.

The device integrates:

- OVERVOLTAGE CLAMP PROTECTION: internally set at 45V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.

- LINEAR CURRENT LIMITER CIRCUIT: limits the drain current  $I_D$  to  $I_{lim}$  whatever the INPUT pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold  $T_{jsh}$ .

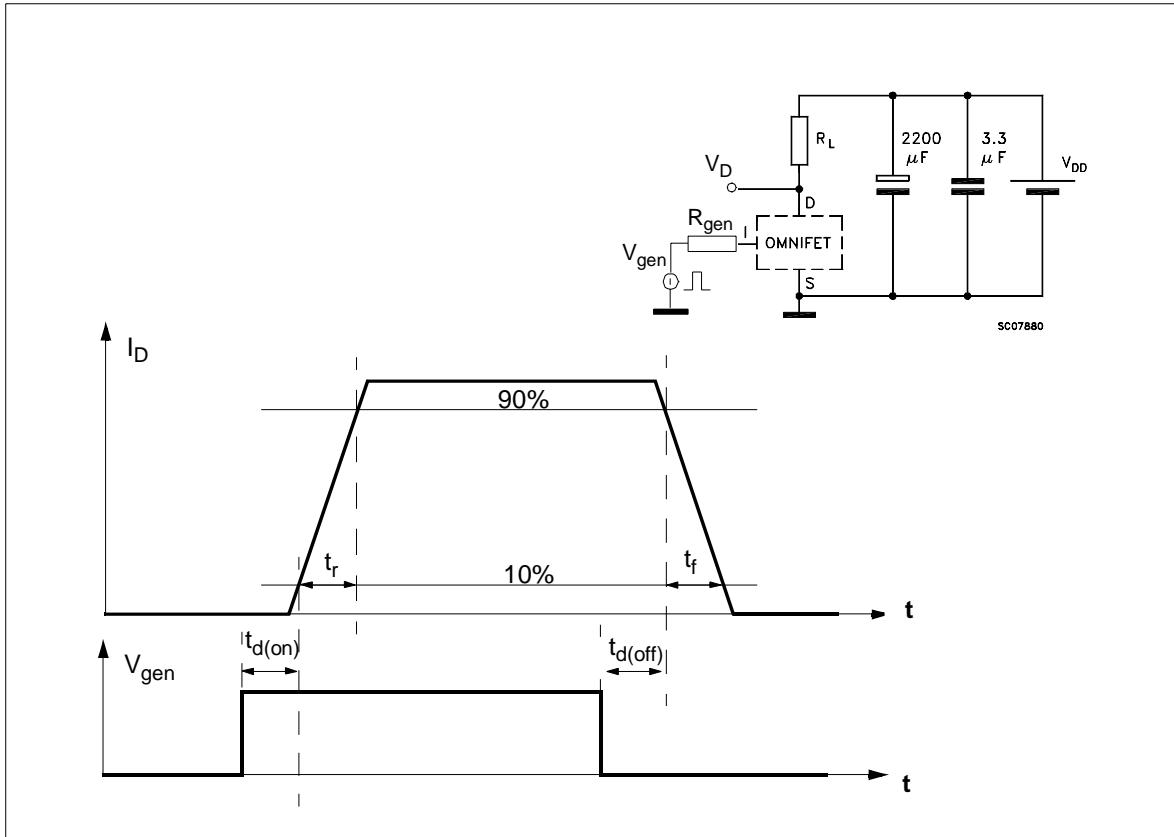
- OVERTEMPERRATURE AND SHORT CIRCUIT PROTECTION: these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs in the range 150 to 190 °C, a typical value being 170 °C. The device is automatically restarted when the chip temperature falls of about 15°C below shut-down temperature.

- STATUS FEEDBACK: in the case of an overtemperature fault condition ( $T_j > T_{jsh}$ ), the device tries to sink a diagnostic current  $I_{gf}$  through the INPUT pin in order to indicate fault condition. If driven from a low impedance source, this current may be used in order to warn the control circuit of a device shutdown. If the drive impedance is high enough so that the INPUT pin driver is not able to supply the current  $I_{gf}$ , the INPUT pin will fall to 0V. **This will not however affect the device operation: no requirement is put on the current capability of the INPUT pin driver except to be able to supply the normal operation drive current  $I_{ISS}$ .**

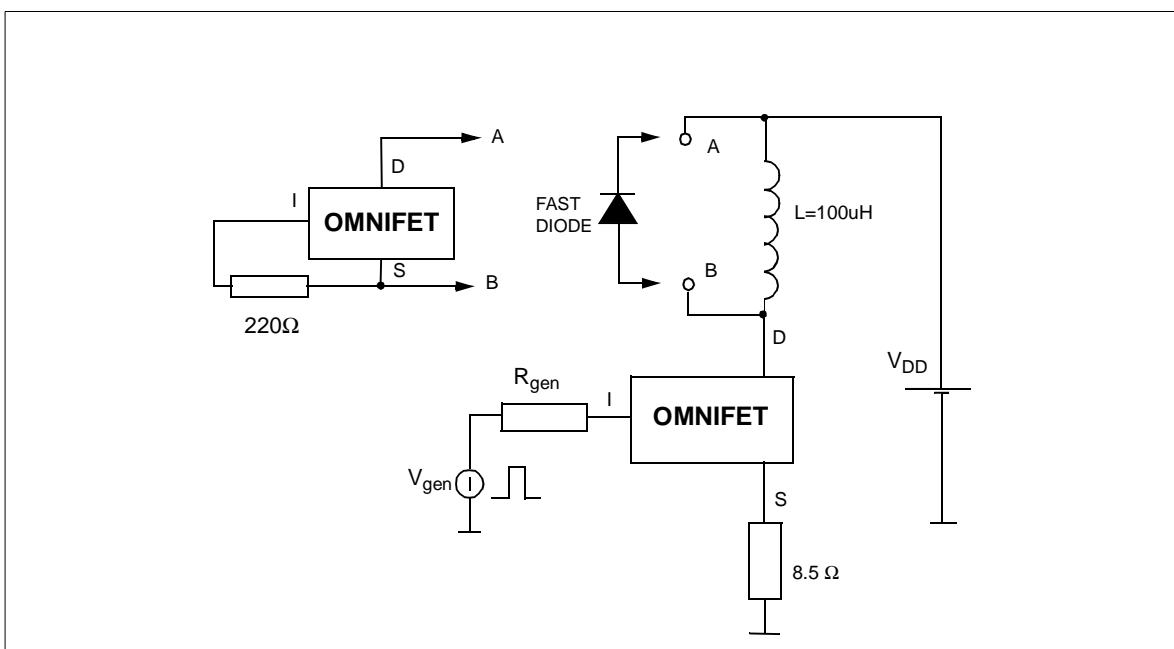
Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit.

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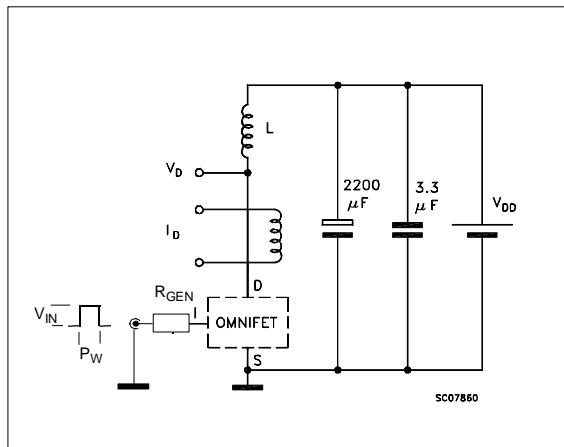
**Fig.1:** Switching Time Test Circuit for Resistive Load



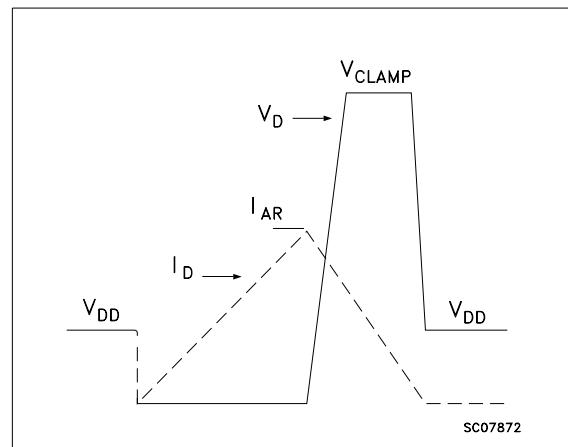
**Fig.2:** Test Circuit for Diode Recovery Times



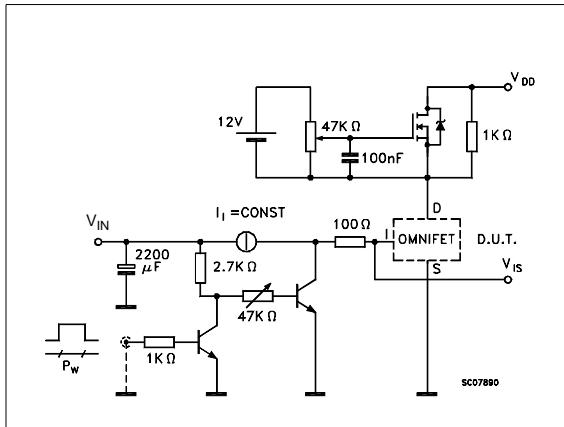
**Fig. 3:** Unclamped Inductive Load Test Circuits



**Fig. 4:** Unclamped Inductive Waveforms

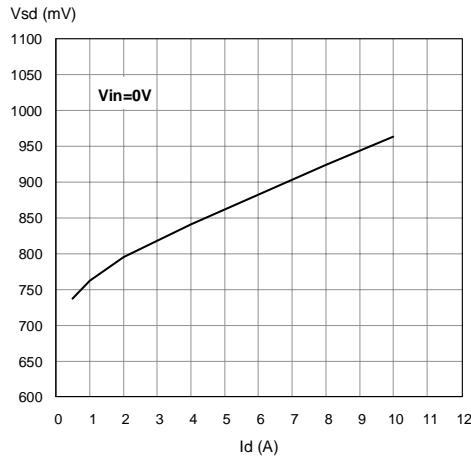


**Fig. 5:** Input Charge Test Circuit

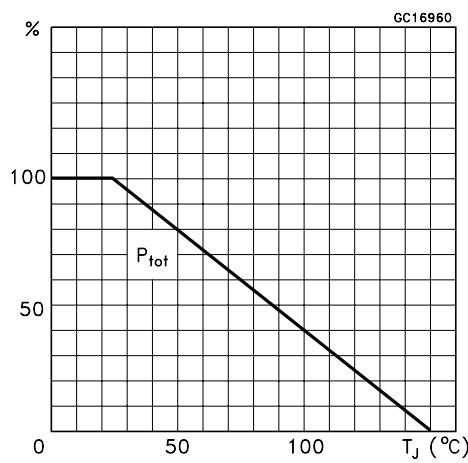


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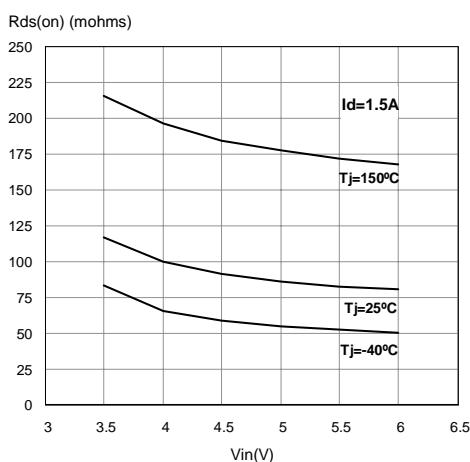
### Source-Drain Diode Forward Characteristics



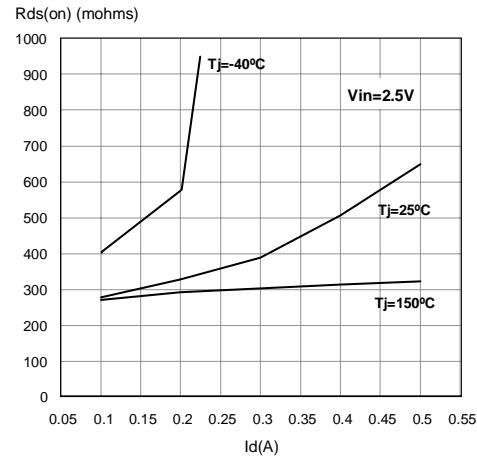
### Derating Curve



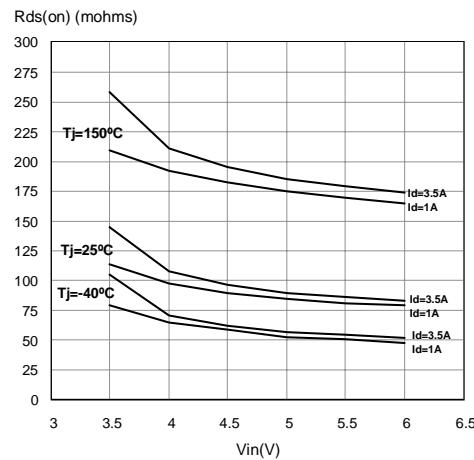
### Static Drain-Source On resistance Vs. Input Voltage



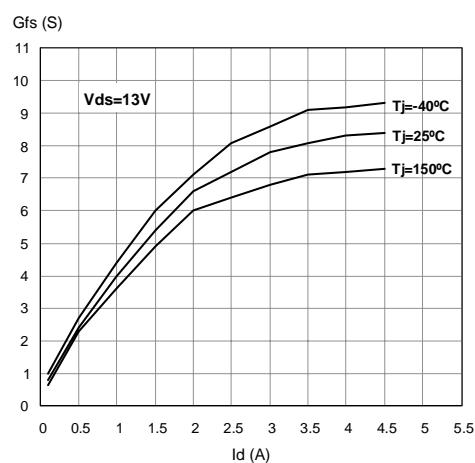
### Static Drain Source On Resistance



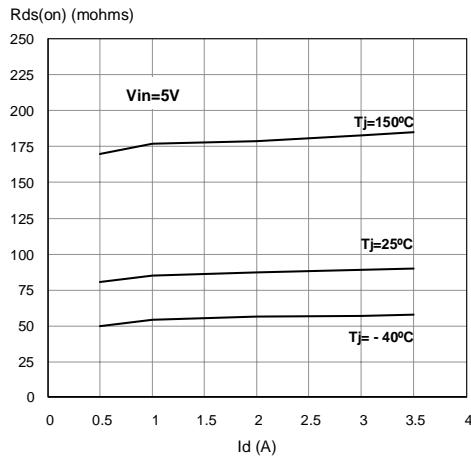
### Static Drain-Source On resistance Vs. Input Voltage



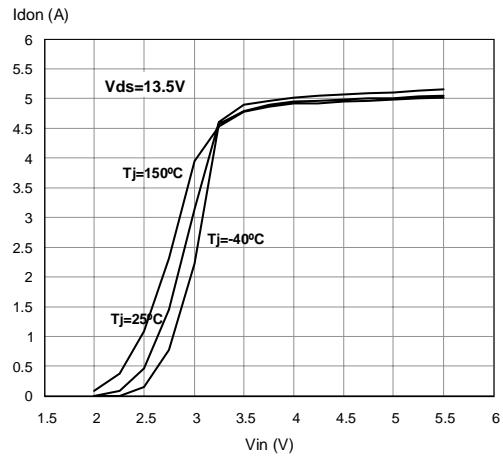
### Transconductance



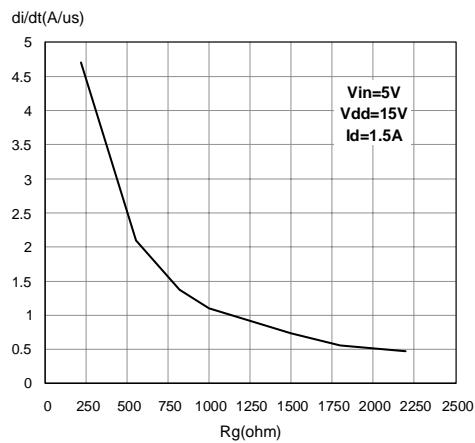
Static Drain-Source On Resistance Vs. Id



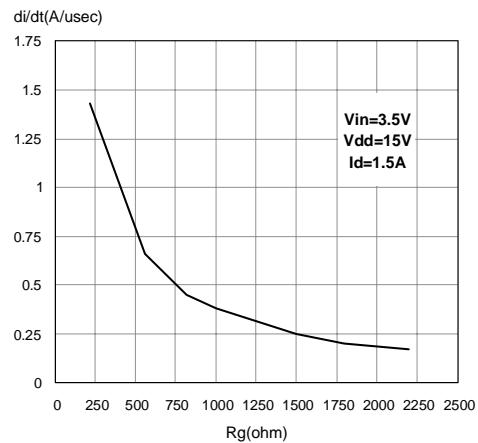
Transfer Characteristics



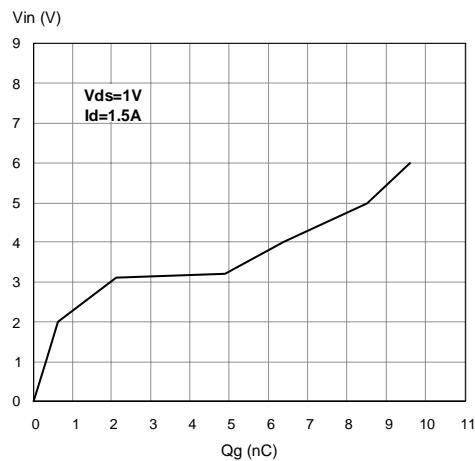
Turn On Current Slope



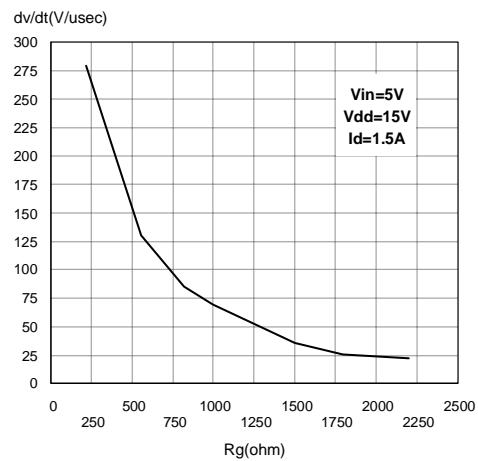
Turn On Current Slope



Input Voltage Vs. Input Charge

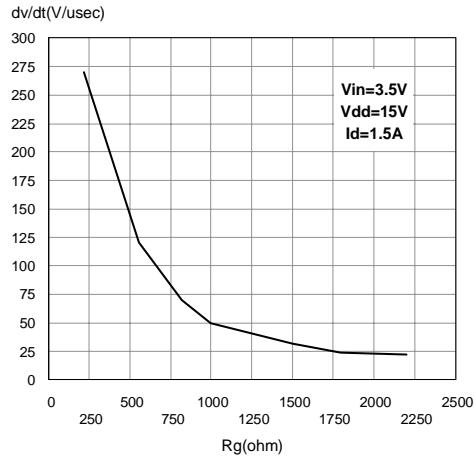


Turn off drain source voltage slope

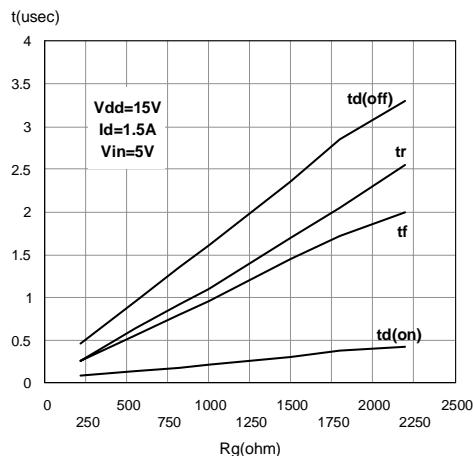


## VNS3NV04D

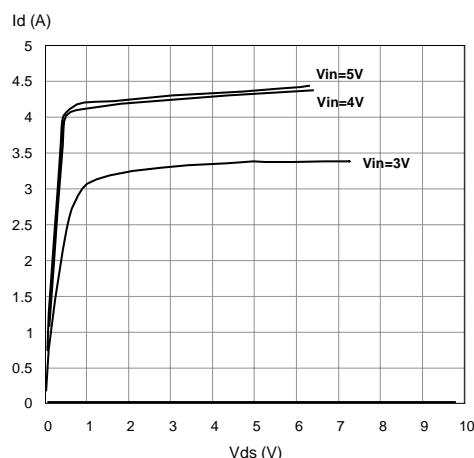
Turn Off Drain-Source Voltage Slope



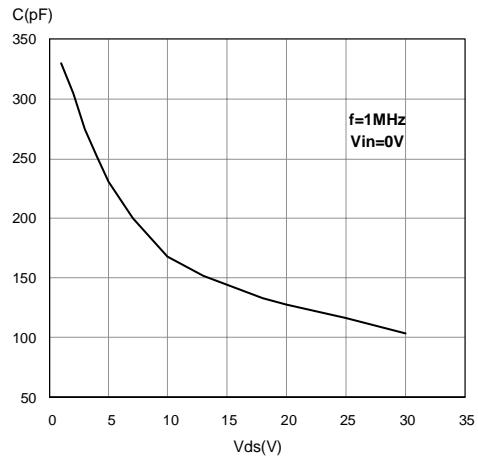
Switching Time Resistive Load



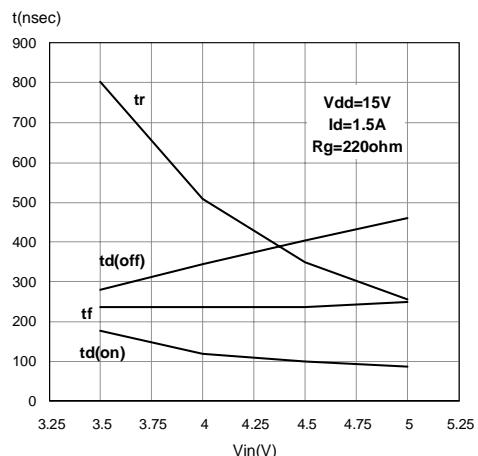
Output Characteristics



Capacitance Variations

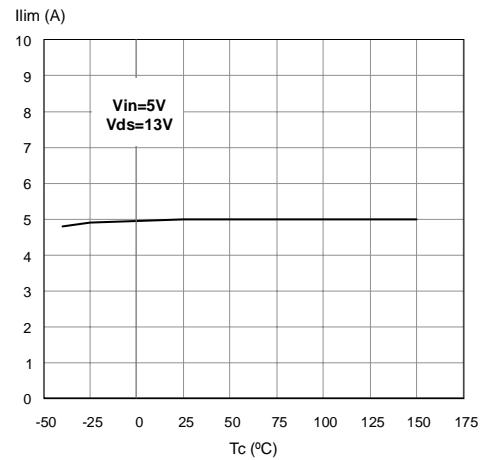
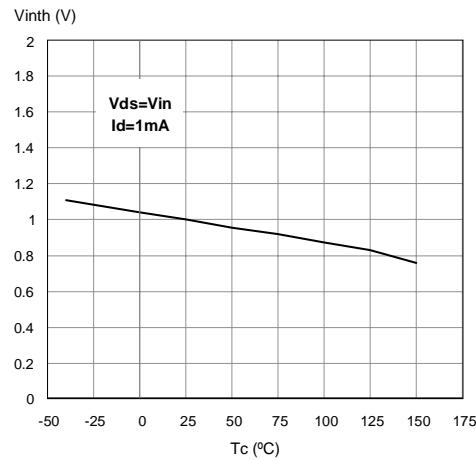


Switching Time Resistive Load

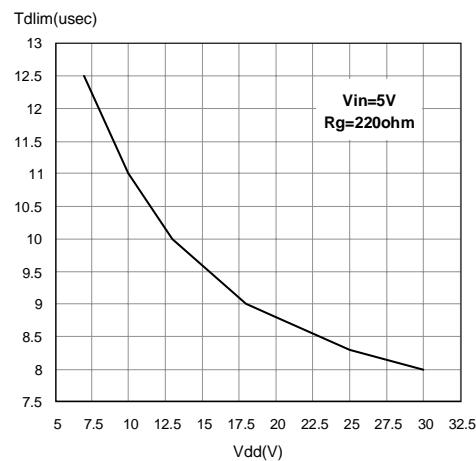


Normalized On Resistance Vs. Temperature

Normalized Input Threshold Voltage Vs. Normalized Current Limit Vs. Junction Temperature



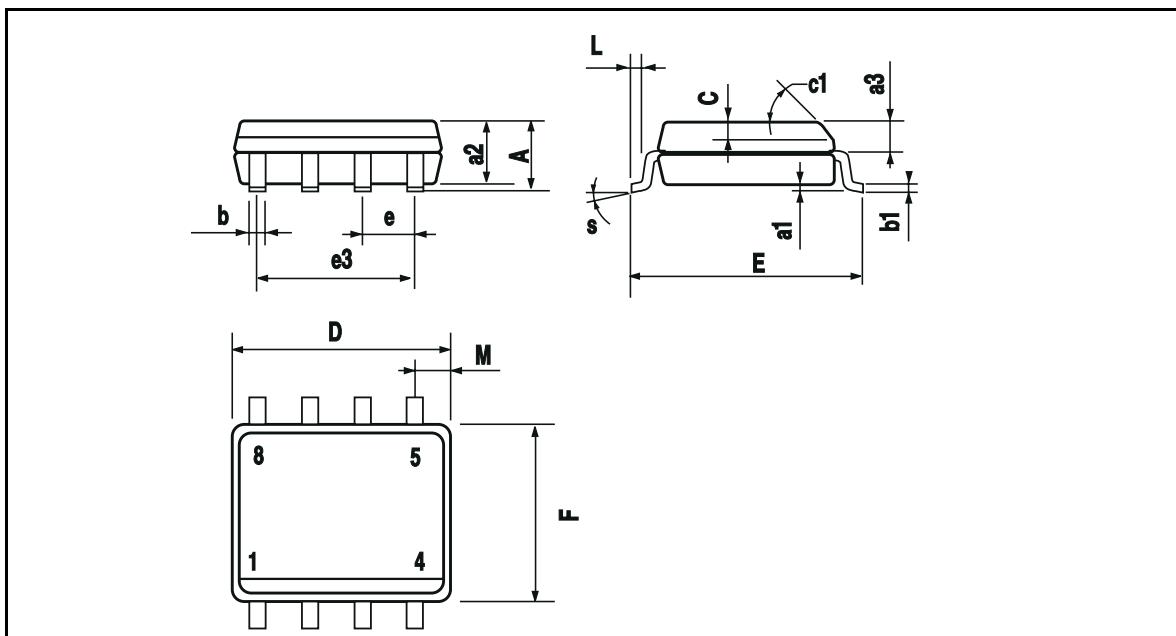
#### Step Response Current Limit



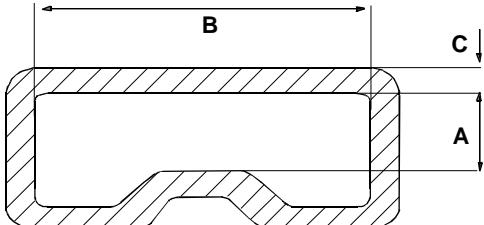
## VNS3NV04D

### SO-8 MECHANICAL DATA

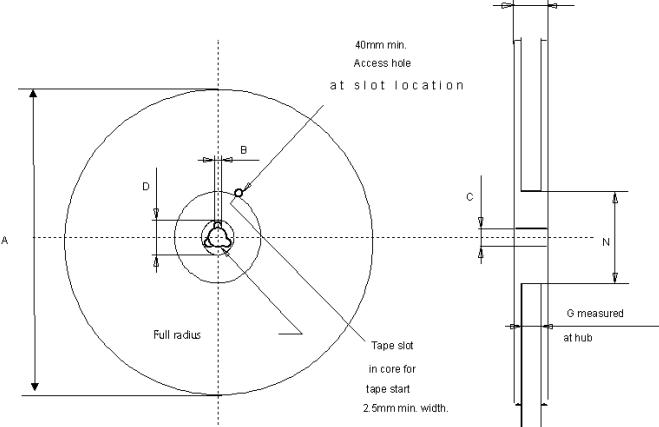
| DIM. | mm.       |      |      | inch  |       |       |
|------|-----------|------|------|-------|-------|-------|
|      | MIN.      | TYP. | MAX. | MIN.  | TYP.  | MAX.  |
| A    |           |      | 1.75 |       |       | 0.068 |
| a1   | 0.1       |      | 0.25 | 0.003 |       | 0.009 |
| a2   |           |      | 1.65 |       |       | 0.064 |
| a3   | 0.65      |      | 0.85 | 0.025 |       | 0.033 |
| b    | 0.35      |      | 0.48 | 0.013 |       | 0.018 |
| b1   | 0.19      |      | 0.25 | 0.007 |       | 0.010 |
| C    | 0.25      |      | 0.5  | 0.010 |       | 0.019 |
| c1   | 45 (typ.) |      |      |       |       |       |
| D    | 4.8       |      | 5.0  | 0.188 |       | 0.196 |
| E    | 5.8       |      | 6.2  | 0.228 |       | 0.244 |
| e    |           | 1.27 |      |       | 0.050 |       |
| e3   |           | 3.81 |      |       | 0.150 |       |
| F    | 3.8       |      | 4.0  | 0.14  |       | 0.157 |
| L    | 0.4       |      | 1.27 | 0.015 |       | 0.050 |
| M    |           |      | 0.6  |       |       | 0.023 |
| F    | 8 (max.)  |      |      |       |       |       |



## SO-8 TUBE SHIPMENT (no suffix)

|   |  |           |     |           |      |                           |     |   |     |   |   |                 |     |
|---|--|-----------|-----|-----------|------|---------------------------|-----|---|-----|---|---|-----------------|-----|
|  | <table border="1"> <tr><td>Base Q.ty</td><td>100</td></tr> <tr><td>Bulk Q.ty</td><td>2000</td></tr> <tr><td>Tube length (<math>\pm 0.5</math>)</td><td>532</td></tr> <tr><td>A</td><td>3.2</td></tr> <tr><td>B</td><td>6</td></tr> <tr><td>C (<math>\pm 0.1</math>)</td><td>0.6</td></tr> </table> | Base Q.ty | 100 | Bulk Q.ty | 2000 | Tube length ( $\pm 0.5$ ) | 532 | A | 3.2 | B | 6 | C ( $\pm 0.1$ ) | 0.6 |
| Base Q.ty   | 100  |           |     |           |      |                           |     |   |     |   |   |                 |     |
| Bulk Q.ty   | 2000   |           |     |           |      |                           |     |   |     |   |   |                 |     |
| Tube length ( $\pm 0.5$ )   | 532  |           |     |           |      |                           |     |   |     |   |   |                 |     |
| A   | 3.2  |           |     |           |      |                           |     |   |     |   |   |                 |     |
| B   | 6  |           |     |           |      |                           |     |   |     |   |   |                 |     |
| C ( $\pm 0.1$ )   | 0.6  |           |     |           |      |                           |     |   |     |   |   |                 |     |
| All dimensions are in mm.   |  |           |     |           |      |                           |     |   |     |   |   |                 |     |

## TAPE AND REEL SHIPMENT (suffix "13TR")

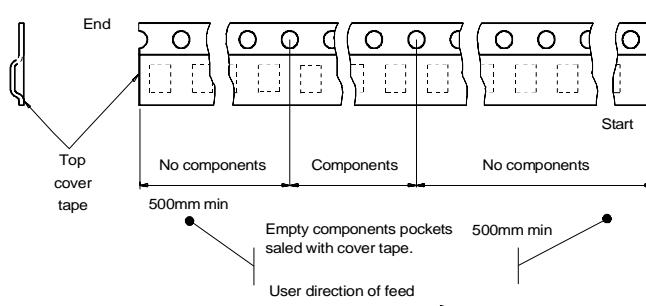
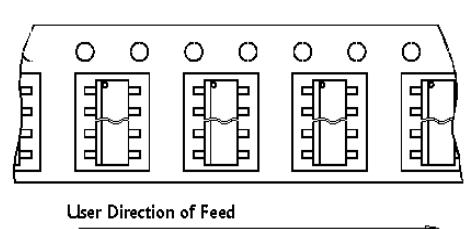
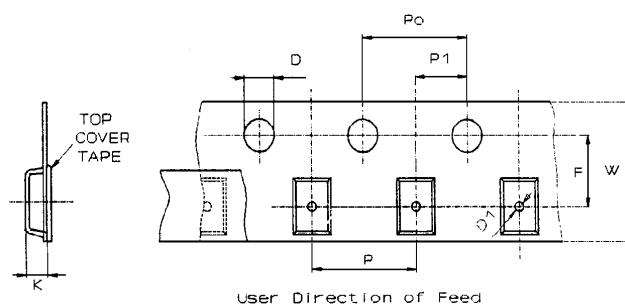
|  |   |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
|--|---|-----------|------|-----------|------|---------|-----|---------|-----|-----------------|----|---|------|--------------|------|---------|----|---------|------|
|  | <b>REEL DIMENSIONS</b> <table border="1"> <tr><td>Base Q.ty</td><td>2500</td></tr> <tr><td>Bulk Q.ty</td><td>2500</td></tr> <tr><td>A (max)</td><td>330</td></tr> <tr><td>B (min)</td><td>1.5</td></tr> <tr><td>C (<math>\pm 0.2</math>)</td><td>13</td></tr> <tr><td>F</td><td>20.2</td></tr> <tr><td>G (+ 2 / -0)</td><td>12.4</td></tr> <tr><td>N (min)</td><td>60</td></tr> <tr><td>T (max)</td><td>18.4</td></tr> </table> | Base Q.ty | 2500 | Bulk Q.ty | 2500 | A (max) | 330 | B (min) | 1.5 | C ( $\pm 0.2$ ) | 13 | F | 20.2 | G (+ 2 / -0) | 12.4 | N (min) | 60 | T (max) | 18.4 |
| Base Q.ty  | 2500  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| Bulk Q.ty  | 2500  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| A (max)  | 330   |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| B (min)  | 1.5   |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| C ( $\pm 0.2$ )  | 13  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| F  | 20.2  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| G (+ 2 / -0)   | 12.4  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| N (min)  | 60  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| T (max)  | 18.4  |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |
| All dimensions are in mm.  |   |           |      |           |      |         |     |         |     |                 |    |   |      |              |      |         |    |         |      |

## TAPE DIMENSIONS

According to Electronic Industries Association (EIA) Standard 481 rev. A, Feb 1986

|                   |                    |     |
|-------------------|--------------------|-----|
| Tape width        | W                  | 12  |
| Tape Hole Spacing | P0 ( $\pm 0.1$ )   | 4   |
| Component Spacing | P                  | 8   |
| Hole Diameter     | D ( $\pm 0.1/-0$ ) | 1.5 |
| Hole Diameter     | D1 (min)           | 1.5 |
| Hole Position     | F ( $\pm 0.05$ )   | 5.5 |
| Compartment Depth | K (max)            | 4.5 |
| Hole Spacing      | P1 ( $\pm 0.1$ )   | 2   |

All dimensions are in mm.



## **VNS3NV04D**

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